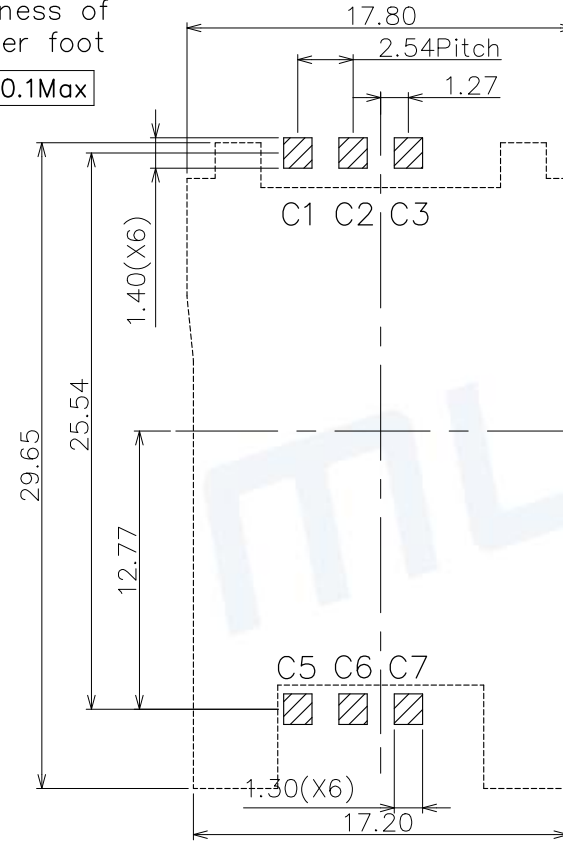
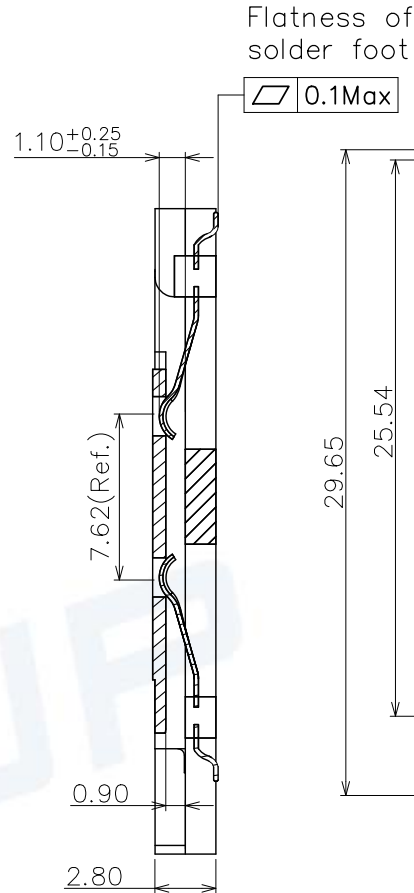
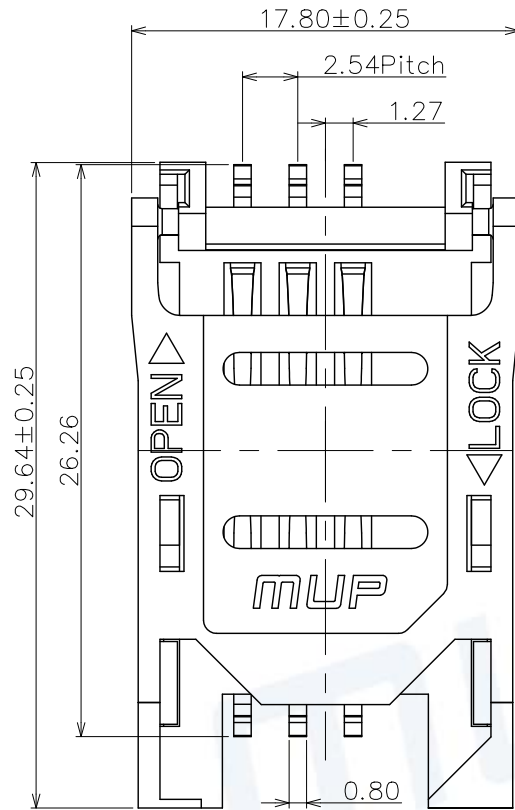
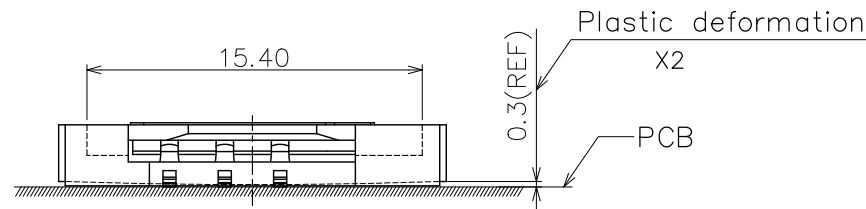
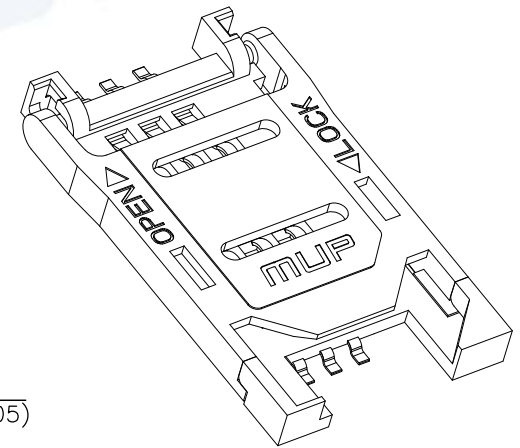


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1	新开	Simon	Jimmy	Lynn	2006.3.10
X2	增加主体塑性变形尺寸	Simon	huabo	Lynn	2020.9.17



RECOMMENDED P.C.B LAYOUT  
COMPONENT SIDE(TOLERANCE ±0.05)

- TECHNICAL CHARACTERISTICS
- General Characteristics  
Dimensions: 29.65LX17.80WX2.80H mm  
Weight: Approx1.14±0.20g  
Durability: 5,000 cycles min.
  - Electrical Characteristics  
Contact resistance: 50mΩ typical,100mΩ max  
Insulation resistance:>1000MΩ/500V DC
  - Solderability  
Vapor phase: 215°C,30sec.Max  
IR reflow: 250°C,5sec.Max  
Manual soldering: 370°C,3sec.Max
  - Environmental Characteristics  
Operating temperature: -40°C~+85°C  
Operating humidity: 10%~+95%RH



ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	BASE	1	Hi-temp Thermoplastic	Black UL94V-0
2	COVER	1	Hi-temp Thermoplastic	Black UL94V-0
3	DATA CONTACT	6	Copper Alloy	Contact area:5u"Au plated

Unless otherwise specified, other tolerance are:

X	±0.35	X'	±5'
X.X	±0.25	X.X'	±4'
X.XX	±0.15	X.XX'	±3'
X.XXX	±0.10	X.XXX'	±2'

**MUP** MUP INDUSTRIAL CO.,LTD.

NAME: **SIM Card Connector**

MODEL NO: **MUP C713-27**

TYPE: **H2.8 without post 6p**

PROJ.	UNIT	SCALE	DRAWN	HUABO	SEP.18.2018	DWG NO.:	
	mm	1:1	CHECKED	Jimmy	SEP.18.2018	DWG-MUP-C713-027	
CUSTOMER DRAWING			APPROVAL	Jun	SEP.18.2018	SHEET	REVISION
						1/1	X2

